

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Sumio IIDA</td><td>08/24/2007</td></tr><tr><td>Masami IMAMURA</td><td>08/24/2007</td></tr><tr><td>Yuuji TANAKA</td><td>11/12/2007</td></tr><tr><td>Kazuhiro SHIMODA</td><td>11/06/2007</td></tr><tr><td>Hirofumi HORI</td><td>11/06/2007</td></tr><tr><td>Akira MOTOKI</td><td>11/15/2007</td></tr><tr><td>Shizuo MORI</td><td>11/15/2007</td></tr></tbody></table>	Name	Execution Date	Sumio IIDA	08/24/2007	Masami IMAMURA	08/24/2007	Yuuji TANAKA	11/12/2007	Kazuhiro SHIMODA	11/06/2007	Hirofumi HORI	11/06/2007	Akira MOTOKI	11/15/2007	Shizuo MORI	11/15/2007	
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Shizuo MORI	11/15/2007																
RECEIVING PARTY DATA																	
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State/Country:	JAPAN																
Postal Code:	541-0041																
PROPERTY NUMBERS Total: 1																	
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11883746</td></tr></tbody></table>	Property Type	Number	Application Number:	11883746													
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Application Number:	11883746																
CORRESPONDENCE DATA																	
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ATTORNEY DOCKET NUMBER:	12137-0008																

PATENT

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NAME OF SUBMITTER:

Christopher W. Brody

Total Attachments: 2

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ASSIGNMENT

Docket No.:

12137-0008

This is an Assignment of the following rights, title and interest:

☒ United States of America rights, title and interest in the invention

☒ Foreign rights, title and interest in the invention

☒ International Application No. PCT/JP2006/302280

Date of Filing: 09/02/2006

☐ United States Patent Application Serial No. _____

Date of Filing: _____

Title of the Invention: Two-Pack-Type Seizing Inhibitor for Hot Plastic Working and Process for Producing Seamless Tube With the Same

Inventors (assignors): Sumio IIDA, Masami IMAMURA, Yuuji TANAKA, Kazuhiro SHIMODA and Hirofumi HORI of c/o SUMITOMO METAL INDUSTRIES, LTD.
5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi, Osaka 541-0041 Japan and,
Akira MOTOKI and Shizuo MORI of c/o PALACE CHEMICAL CO., LTD.,
11-16, Fukuura 1-chome, Kanazawa-ku, Yokohama-shi,
Kanagawa 236-0004, Japan

Assignee: SUMITOMO METAL INDUSTRIES, LTD. of 5-33, Kitahama 4-chome, Chuo-ku, Osaka-shi,
Osaka 541-0041 Japan

Whereas, we, the above-identified Inventors, have invented certain new and useful improvements in the Invention identified above and described in the above-identified patent application(s) and/or patent(s) (hereinafter referred to as "Invention");

And, whereas we desire to assign our above-identified rights, title and interest in the Invention to the above-identified assignee;

Now, this indenture witnesseth, that for good and valuable consideration, the receipt whereof is hereby acknowledged;

We hereby assign, sell and transfer our above-identified rights, title and interest in said Invention, said applications(s) as identified above, including any divisions, continuations, and continuations-in-part thereof, and in and to any and all Letters Patent of the United States, which may be granted or have granted for said Invention, and in and to any and all reissues and reexaminations thereof, and in and to any and all priority rights, Convention rights, and other benefits accruing or to accrue to us with respect to the filing of applications for patents or securing of patents in the United States, unto said Assignee.

And we hereby authorize and request the Commissioner of Patents and Trademarks to issue any United States Letters Patent which may issue for said Invention to said Assignee, as assignee of the whole right, title and interest thereto;

And we further agree to sign and execute all necessary and lawful future documents, including applications, for filing divisions, continuations and continuations-in-part of said application for patent, and/or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid Invention, as the Assignee or its Designee(s) may from time to time require and prepare at its own expense.

Sumio Iida
Signature: Sumio IIDA

2007. 8. 24
Date

Masami Imamura
Signature: Masami IMAMURA

2007. 8. 24
Date

Yuuji Tanaka
Signature: Yuuji TANAKA

2007. 11. 12
Date

Kazuhiro Shimoda
Signature: Kazuhiro SHIMODA

2007. 11. 06
Date

Hirofumi Hori
Signature: Hirofumi HORI

2007. 11. 06
Date

Akira Motoki
Signature: Akira MOTOKI

2007. 11. 15
Date

Shizuo Mori
Signature: Shizuo MORI

2007. 11. 15
Date